



Practitioner's Docket No.: 283_237.10

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

Robert J. Hennick, Colleen P. Gannon, Klaus Kremmin Sr.

April 17, 2001

Ser. No.: 09/312,479

Art Unit: 2878

Filed: May 17, 1999

Examiner: T. Luu

For: OPTICAL AND IMAGE SENSOR SUBASSEMBLY ALIGNMENT AND MOUNTING METHOD

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail addressed to Assistant Commissioner for Patents, Washington D.C. 20231, on April 17, 2001.

Tammy S. Senecal
Tammy S. Senecal

Assistant Commissioner for Patents
Washington, DC 20231

AMENDMENT

Sir:

In response to the Office Action of January 17, 2001, please amend the above-captioned application as follows:

In the Claims:

Please amend claims 1, 13, 26, and 32 as follows:

All claims have been recreated for the convenience of the Examiner.

- 1 1. (Amended) A method for mounting an optical subassembly of an optical reading
2 device to an image sensor subassembly of an optical reading device, said method comprising
3 the steps of:
4 moving said optical subassembly and said image sensor subassembly in proximity
5 with one another; and
6 without a substantially rigid component part of said image sensor assembly being
7 substantially benched in either of an x or y direction against a substantially rigid component
8 part of said optical subassembly; and soldering said optical and image sensor assemblies
9 together using a solder material.

- 1 2. The method of claim 1, further comprising the step of forming a solderable surface
2 on at least one of said optical subassemblies or said image sensor subassemblies.

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01 FC:103
02 FC:102

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